

SRF Material Options for FCC

Sarah Aull on behalf of the FCC RF & WP3 working group

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Accelerating gradient is a design choice Qo is given by the temperature, frequency and material choice

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R_{res} is independent of T R_{res} depends only slightly on f Field dependence depends on material

Material	Achieved	Expected in mass production
Bulk Nb	0.5 - 20 nΩ	10-15 nΩ
Nb/Cu	0.5 - 30 nΩ	20 nΩ



Bulk Niobium - A Well-Known Technology





High level of expertise High cost for raw material Requires magnetic shielding Only operation at < 2.1 K

Improved surface preparation techniques Higher E_{acc} in mass production



N Doping - Pushing the Limits of Bulk Niobium





Very high Q at 2 K High cost for raw material Requires magnetic shielding Reduced quench field Performance at lower frequencies? Performance at 4.2 K?

Nb/Cu - New Coating Techniques on the Rise





Lower raw material costs High thermal stability No magnetic shielding Reduced microphonic

Only low E_{acc} due to strong Q-Slope Mitigated Q-Slope for energetic condensation techniques

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Nb3Sn/Nb - Beyond Niobium



Very high Q at 4.2 K High cost for raw material Requires magnetic shielding Premature quenching Not a mature technology yet Multicell cavities Higher quench field Mechanical behavior Nb3Sn/Cu (See Poster by K. Ilyina)

Perspectives for R&D





4.5 K operation: Optimise mean free path Cure Q-slope A15 materials

2 K operation: Optimise residual resistance Cure Q-slope

Cryogenic Power for the Top Machine





The perspective of cavity performances yields similar cryogenic losses for Nb/Cu at 400 MHz and 4.5 K and bulk Nb at 800 MHz and 2.0 K. A15 Materials might further reduce the cryogenic power.

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Conclusion



- The application of Nb/Cu technology would reduce the installation and running costs of the cryogenic system as well as the cost of cavities and cryomodules.
- Energetic condensation techniques promise cavity performances at 4.5 K comparable to bulk niobium.
- A15 materials such as Nb3Sn may even further decrease the dynamic losses at 4.5 K.

